

# Material science Question Papers (AD-302)

## MATERIAL SCIENCE (AMIE)

### Q. No. Year Questions

- 1a S-2000 Calculate the volume of FCC unit cell in terms of the atomic radius **R**. Also calculate It's packing factor.
- 1b S-2000 Why are the most metals and alloys used in common applications polycrystalline in nature ? Is it possible to have single crystals of metals and alloys ? Describe a common method for measuring grain size in metals and alloy
- 2a S-2000 What is Burger's Vector ? How does dislocation density influence mechanical properties ? Is dislocation density in materials influenced by annealing ?
- 2b S-2000 Explain phenomenon of yielding in mild steel. Why is the yield point in copper not distinct ?
- 3a S-2000 Briefly explain the mechanism of fatigue crack initiation in metals ?
- 3b S-2000 How does creep differ from high temperature fatigue ? Explain different stages of creep ?
- 3c S-2000 What is Thermal Fatigue, explain with an example ?
- 4a S-2000 What is diamagnetism and paramagnetism? Explain in brief. Name one material of each type ?
- 4b S-2000 Calculate (i) The saturation magnetisation and (ii) the saturation flux density for Nickel, which has a density of  $8.9 \text{ g/cm}^3$ . Atomic weight of Nickel = 58.71. Magnetic moment per Nickel atom =  $0.6 \text{ Bohr magneton } \mu_B = 9.27 \times 10^{-24} \text{ J/T}$  and  $\mu_0 = 4\pi \times 10^{-7} \text{ H/m}$
- 4c S-2000 Cite the similarities and differences between ferromagnetic and ferrimagnetic materials.
- 5a S-2000 What is the nature of bonding in semiconductor materials ? What is meant by semiconductor device typical components of a semiconductor device ? What are dielectric materials and explain their applications. Give one dielectric material.
- 5b S-2000 What is the distinction between electronic and ionic conduction ? Explain with suitable examples ?
- 5c S-2000 Is it possible for compound semiconductors to exhibit intrinsic behaviour ?
- 6a S-2000 A bimetallic strip is constructed from strips of two different metals that are bonded along their lengths. Such a device may be used in a thermostat to regulate temperature.
- 6b S-2000 The thermal conductivity of plain carbon steel is greater than that of stainless steel . Explain why it is so

- 7a S-2000 What is meant by critical resolved shear stress. Derive its expression.
- 7b-i S-2000 Explain phenomenon of Recovery
- 7b-ii S-2000 Explain phenomenon of Recrystallisation
- 7b-iii S-2000 Explain phenomenon of Grain growth
- 8a-i S-2000 Full Annealing, assuming a medium carbon steel, explain final micro structure.
- 8a-ii S-2000 Normalising, assuming a medium carbon steel, explain final micro structure.
- 8a-iii S-2000 Quenching and Tempering, assuming a medium carbon steel, explain final micro structure.
- 8b S-2000 Cite three sources of internal residual stress in metal components. What are the possible adverse consequences of these stresses ?
- 8c S-2000 Briefly explain the difference between Hardness and Hardenability.
- 1a W-2000 Describe n-type and p-type semiconductors with structural reasoning. Give an example for each.
- 1b W-2000 Explain ferromagnetism with B-H loop
- 1c W-2000 What is slip ? How it is measured ? Distinguish slip with twinning. Why stress required for slip in actual metal is considerably less than the theoretically calculated stress.
- 1d W-2000 What is precipitation hardening ? How does it differ with dispersion hardening ?
- 2a W-2000 Calculate the number of atoms per unit cell of metallic zinc. Draw (111) plane and  $\langle 111 \rangle$  direction in a cubic lattice.
- 2b W-2000 Calculate the planar density of atoms in (111) plane of aluminium. [Atomic radius of aluminium = 0.143 nm]
- 2c W-2000 Define [i] Screw dislocation [ii] Jog [iii] Stacking Fault Energy [iv] Shockley Partial [v] Low angle grain boundary [vi] Critical resolved shear stress
- 2d W-2000 Discuss the mechanism of dislocation multiplication by Frank-Read Source.
- 3a W-2000 Copper is a conductor but silicon is a semiconductor- explain and illustrate with their electronic configurations.
- 3b W-2000 State the basic differences between metallic Bond and Ionic Bond
- 3c W-2000 Why does continuous cold working make a material harder ? How can its softness be recovered ?
- 3d W-2000 Rolling of pure lead at room temperature can be called hot rolling - explain
- 4a W-2000 Name a thermoplastic and a thermosetting polymer. State two characteristics in each case.
- 4b W-2000 Discuss the electrochemical phenomenon of corrosion.

- 4c W-2000 Describe [i] Cathodic Protection [ii] Anodic Protection in this connection.
- 4d W-2000 Explain the phenomenon of sensitization in stainless steel.
- 5a W-2000 Draw a nominal stress-strain diagram of a ductile material and indicate [i] Proportional Limit [ii] Yield Point of necking. Show how yield strength and the percentage of elongation can be measured from the diagram.
- 5b W-2000 Explain temper brittleness and its problem.
- 5c W-2000 What is Martensite? What are  $M_s$  and  $M_{90}$  in T-T-T diagram? In dual-phase steels, why is the martensite is not preferred?
- 5d W-2000 Difference between Pearlitic reaction and Bainitic reaction.
- 6a W-2000 Distinguish between Fire Clay and Sillimanite refractories. Discuss the importance of Pure Oxide refractories in modern furnaces.
- 6b W-2000 Explain Slip Casting.
- 6c W-2000 Draw a conventional creep curve (high temperature) indicating different stages of creep behaviour and show how creep rate is determined. Explain with reason whether a coarse grained material or a fine grained material is preferred for creep resistance.
- 6d W-2000 How can one justify that creep is a diffusion controlled process.
- 7a W-2000 Annealing produces softer material while normalising produces stronger—justify. During heat treatment, why do eutectoid carbon steels are heated over  $A_{C3}$ , but hypo-eutectoid steels are heated over  $A_{C1}$  only?
- 7b W-2000 Calculate the percentage of pro-eutectoid ferrite and total ferrite in 0.2% carbon steel.
- 7c W-2000 What is brittle to ductile transition temperature? State its importance in materials in sub-zero applications. List at least three materials that can be used in sub-zero environment.
- 7d W-2000 Why (70/30) brass is more ductile than (60/40) brass?
- 8a W-2000 Discuss the effects of following alloying elements in steel (i) Nickel (ii) Tungsten (iii) Manganese.
- 8b W-2000 Explain (i) Strain Hardening Exponent (ii) Super Plasticity.
- 8c W-2000 What is high speed steel? What is red hardness? State the reason of its occurrence.
- 8d W-2000 Enumerate different methods of improving fatigue resistance of materials.
- 1a S-2001 Discuss the structure of an atom with reference to Bohr's Theory. Briefly explain the model proposed by Rutherford.
- 1b S-2001 How is a simple molecule of hydrogen formed? What are the typical intermolecular bonding mechanisms in hydrogen? Explain the intermolecular bonding in hydrogen.
- 1c S-2001 With the help of neat sketches differentiate Grain and Crystal. How does grain formation occur as molten metal solidifies?

to room temperature ?

- 2a S-2001 Define the term Crystal and explain the following terms (i) Space Lattice (ii) Unit cell (iii) Effective number of atoms per unit cell (iv) Packing factor.
- 2b S-2001 What is Polymorphism ? Give atleast two examples of polymorphism in materials.
- 2c S-2001 Describe the method used for identifying planes and directions in a crystal lattice. How are the families of planes and directions represented ?
- 3a S-2001 What is a magnetic dipole ? Explain why only some elements show magnetic behaviour.
- 3b S-2001 Describe following, with the help of neat sketches (i) Ferromagnetism (ii) Paramagnetism (iii) Diamagnetism
- 3c S-2001 Define intrinsic and extrinsic seemiconductors. Explain how holes and electrons are created in an intrinsic semiconductor.
- 4a S-2001 Distinguish between ductils and brittle fractre. Draw typical stress-strain curves for a hypo-eutectoid plain carbon steel and white cast iron and label them.
- 4b S-2001 What are dielectric materials ? Discuss their properties and factors affecting it's properties.
- 4c S-2001 Define fatigue and creep. Describe a creep testing experiment and draw a typical creep curve.
- 5a S-2001 Draw a representative TTT curve for eutectoid steel. What would be the effect of carbon and boran addition on the TTT curve ?
- 5b S-2001 Differentiate between annealing and normalising. Discuss the purposes for which these treatements are done.
- 5c S-2001 What is the difference between hardness and hardenability ? Name different hardness testing machines, used and general testing procedure.
- 6a S-2001 Differentiate between work hardening and precipitation hardening and discuss the mechanism of work hardening.
- 6b S-2001 ritically compare the following (i) Cold Working and Hot Working (ii) Defromation by slip and twinning.
- 6c S-2001 What are the austempering and martempering ? Why are these treatements given only to certain alloys ?
- 7a S-2001 Write short notes on the following (i) Acid and basic refractories and their applications. (ii) Critically resolve the effect of residual stress (iii) Corrosion and it's control (iv) Bearing alloys
- 8a S-2001 Write molecular structures of natural and vulcanized rubber.
- 8b S-2001 Explain why thermoplastics are reshaped at elevated temperatures and not the thermosetting polymers.
- 8c S-2001 What are heat resisting alloys ? Give chemical compositions of rail steel, hadfield steel and coinage bronze
- 1a W-2001 Show that the atomic packing fraction for BCC crystal is 0.68

- 1b W-2001 Briefly describe the electronic structure of an atom.
- 1c W-2001 Name the crystal structures (BCC, FCC or HCP) for the following metals : Magnesium, Alpha Iron, Copper and Zinc.
- 1d W-2001 Distinguish between Unit Cell and Space Lattice.
- 2a W-2001 What were the major differences in Rutherford's nuclear model ? How were these overcome by Bohr's model ?
- 2b W-2001 Explain the terms, True Stress, True Strain, Engineering Stress and Engineering Strain.
- 2c W-2001 Distinguish between upper and lower yield points.
- 3a W-2001 Sketch neatly a typical creep curve and explain its various stages. Show how the curve would alter on varying temperature.
- 3b W-2001 An aluminium bar of 24 mm\*30 mm cross section is under a load of 7000 kg and a steel bar of diameter 10 mm is under a load of 5000 kg. Which part has the greater stress ?
- 3c W-2001 What is meant by ductile-brittle transition temperature ? How can this temperature be controlled ?
- 3d W-2001 Draw neatly the engineering stress-strain curve for mild steel.
- 4a W-2001 By applying the principle of Zone theory explain the difference between conductors, insulators and semiconductors.
- 4b W-2001 Explain why repeatedly dropping a permanent magnet on the floor causes its demagnetisation.
- 4c W-2001 Explain the following (i) Magnetisation (ii) Diamagnetisation (iii) Relative permeability and (iv) Domain.
- 5a W-2001 What are the general properties of polymeric materials ?
- 5b W-2001 Explain briefly a polymerisation mechanism.
- 5c W-2001 Explain two methods of preventing corrosion.
- 5d W-2001 What are the main characteristics of ceramic materials ?
- 5e W-2001 Differentiate between insulators and refractories.
- 6a W-2001 Difference between Cold working and Hot Working.
- 6b W-2001 What is meant by the term "Recovery" in metals ?
- 6c W-2001 How are the bearing alloys classified ? Explain briefly the applications of bearing bronzes.
- 6d W-2001 Explain the phenomenon of work hardening in metals.
- 6e W-2001 Explain the mechanism of slip by dislocation.
- 7a W-2001 What are the purposes of normalising ? How does normalising differ from full annealing ?

- 7b W-2001 What are the benefits of alloying in general ? What are the effects of chromium as alloying element on the properties of steel ?
- 7c W-2001 What are heat resisting steels ? Give a typical composition of a heat resisting steel used for gas turbine blades.
- 7d W-2001 Explain briefly the factors responsible for plastic deformation in polycrystalline materials.
- 8a W-2001 Explain Critical cooling rate.
- 8b W-2001 Explain Jominy's Quench Test.
- 8c W-2001 Explain Bauschinger's Effect.
- 8d W-2001 Explain Galvanic corrosion.
- 8e W-2001 Explain Martensitic transformation.
- 1a S-2002 Draw the planes (110) and (111) in a simple cubic crystal.
- 1b S-2002 Describe primary and secondary bonds with examples.
- 1c S-2002 Copper has an FCC crystal structure and a unit cell with a lattice constant of 0.356 nm. What is its interplanar spacing  $d_{220}$  ?
- 1d S-2002 A hydrogen atom exists with its electron in the  $n=3$  state. The electron undergoes a transition to the  $n=2$  state. Calculate (i) The energy of the photon emitted (ii) Its frequency (iii) Its wavelength (iv) Its energy emitted in the transition.
- 2a S-2002 Calculate the volume of the zinc crystal unit cell by using the following data. Zinc has HCP crystal structure with  $a=0.2665$  nm and  $c=0.4947$  nm.
- 2b S-2002 Explain the mechanism of crack initiation and growth when a metal is subjected to cyclic stresses.
- 2c S-2002 The flow curve equation of annealed 7075 aluminium alloy at room temperature is given by  $\sigma = k \epsilon^n$ , where  $k=700$  MPa and  $n=0.21$ . Calculate the tensile strength of the alloy.
- 3a S-2002 Sketch schematically a generalised creep curve for metallic materials. How does the creep rate vary along the curve? Explain the effect of stress and temperature on the steady state creep rate.
- 3b S-2002 What is the probability of an electron being thermally promoted to the conduction band in (i) Diamond [ $E_g=5.5$  eV] (ii) Silicon [ $E_g=1.07$  eV] at room temperature 25 degree centigrade.  $k=86.2 \times 10^{-6}$  eV.K<sup>-1</sup>.
- 3c S-2002 Explain the various types of magnetism. What is the difference between soft and hard magnets ?
- 4a S-2002 Explain (i) Seebeck Effect (ii) Meissner Effect.
- 4b S-2002 Distinguish between intrinsic and extrinsic semiconductor.

- 4c S-2002 Compute the thermal conductivity  $k$  of sodium at 0 degree centigrade or 273 degree kelvin using below given data:  $I=4.29$  A,  $k=1.38 \times 10^{-3}$ ,  $t_c=3.1 \times 10^{-4}$  sec, number of atoms (BCC)=2,  $m=9.11 \times 10^{-31}$ .
- 4d S-2002 A wire sample 1 mm in diameter by 1m in length of an aluminium alloy is placed in an electrical circuit. A voltage of 432 mV is measured across the length of the wire as it carries a 10 A current. Calculate the conductivity.
- 5a S-2002 Explain briefly : Lead can creep under it's own weight at room temperature.
- 5b S-2002 Explain briefly : Yield point phenomenon is observed in low carbon steel.
- 5c S-2002 Sketch Edge and Screw dislocations.
- 5d S-2002 Explain briefly :Difference in mechanical properties of fine and coarse grained materials.
- 6a S-2002 Explain the meanings and significances of the following properties of refractoris : (i) Pyrometric cone equivalent (ii) Refractoris under load (iii) Spalling.
- 6b S-2002 Distinguish between thermoplastics and thermosetting plastics.
- 6c S-2002 What is meant by the term compounding of plastics ? What are the functions of ingredients used in compounding plastics ?
- 6d S-2002 Zinc is corroding with a current density of  $3.427 \times 10^{-7}$  A/cm<sup>2</sup>. What is the corrosion rate in (i) milligrams per centimetre per second (mcs) and (ii) milligrams per square decimetre per day (mdd) ?
- 7a S-2002 Give the compositions, properties and applications of following : (i) Gun Metal (ii) Duralumin.
- 7b S-2002 Sketch the Fe-Fe<sub>3</sub>C diagram that represents the temperature ranges used for (i) Full Annealing (ii) Normalizing (iii) Spheroidizing (iv) Stress Relief Annealing and (v) Recrystallization Annealing.
- 7c S-2002 Define hardenability. Explain the effect of grain size and chemical composition on hardenability.
- 7d S-2002 Explain the characteristics of martensite.
- 8a S-2002 A tensile stress of 15 mPa applied on [1 10 0] axis of a single crystal of silver is just sufficient to cause slip on the [111] system. Calculate the critical resolved shear stress of silver. [Hint  $\cos \phi = 2/\sqrt{6}$ ,  $\cos \lambda = 1/\sqrt{2}$ ]
- 8b S-2002 Distinguish between martempering and austempering in terms of (i) Process (ii) Advantages (iii) Applications (iv) Limitation with neat sketches.
- 8c S-2002 Explain the characteristics of tin based Babbit metal that make it suitable as a bearing material.
- 8d S-2002 Distinguish between (i) Hot shortness and Cold shortness (ii) Hot working and Cold working.
- 1a W-2002 What do you understand by metallic bonding ? Why it is non-directional in nature ? Distinguish it from covalent bonding. What is meant by secondary bonding ?
- 1b W-2002 Explaining (i) Why covalent bonded solids are poor electrical conductors ? (ii) Why Ionically bonded solids are poor electrical conductors ?

- melting points ? (iii) How is the equilibrium distance of separation between two like atoms is fixed at degree of freedom ? (iv) What is meant by bond energy (iv) Calculate the void fraction in BCC crystal.
- 2a W-2002 Draw two FCC unit cells side by side. Construct from within the two, one body centered tetragonal unit cell. State its c/a ratio.
- 2b W-2002 What is Burger's Vector ? State, how you can determine the Burger's Vector of an edge dislocation.
- 2c W-2002 What is critical resolved shear stress ? Derive an expression for the same.
- 2d W-2002 Describe how the microstructural changes are effected when a single phase alloy is heavily cold worked and then annealed.
- 3a W-2002 Distinguish between (i) Slip and twinning (ii) Elastic and Plastic Strain (iii) Single crystalline and polycrystalline materials (iv) Point defects and line defects in crystals (v) Yield Strength and Ultimate Strength.
- 3b W-2002 What is meant by Polygonisation ? Explain the mechanism involved in Polygonisation.
- 4a W-2002 What is creep ? Draw a typical creep curve showing different stages of creep. Explaining the mechanisms involved in each stage of creep.
- 4b W-2002 (i) Describe the mechanism of brittle fracture in materials. (ii) Explain why fatigue failure is initiated from the surface of a body.
- 5a W-2002 Explain-Metals are solids with partly filled zones.
- 5b W-2002 Explain-Repulsive force between two like atoms is short range in nature.
- 5c W-2002 Explain-Semiconductors have negative temperature coefficient of resistance.
- 5d W-2002 Explain-Pressure of small scale discontinuities in metals increases its resistivity whereas larger scale microstructural features do not affect the resistivity.
- 5e W-2002 Transition metals are either ferromagnetic or strongly paramagnetic in nature.
- 6 W-2002 Write short note on (i) Brillouin Zones (ii) Impurity semiconductors (iii) Dielectric materials (iv) Free electron theory of metals (v) factors affecting electrical resistance of materials.
- 7 W-2002 Differentiate between (i) Annealing and Normalising (ii) TTT and CCT diagrams (iii) Hardness and Hardenability (iv) Martensite and Pearlite (v) Cast Iron and Steel.
- 8a W-2002 Enumerate the various types of corrosions normally encountered in materials. Explain the mechanism of stress corrosion cracking. Describe some useful methods of corrosion control.
- 8b W-2002 What do you understand by polymerisation ? State the characteristics of long chain polymers. Describe the deformation behaviour of plastics.

- For BCC iron, compute (i) the interplaner spacing (ii) the diffraction angle for [211] set of planes. The lattice constant for Fe is 0.2866 nm [2.866 Å]. Also assume the monochromatic radiation having a wavelength of 0.1542 nm is used, and order of reflection is 1.
- 1a S-2003
- 1b S-2003 Indicate millers indice for (i) Octahedral Plane (ii) Dodecahedral Plane. In BCC and FCC structures showing of their unit cell.
- 1c S-2003 What will be the Miller indices for close packed directions in γ iron ? Show with a neat sketch.
- 2a S-2003 Differentiate between the mechanisms of Fatigue and Creep.
- 2b S-2003 Explain the various types of magnetisms. What is the difference between Soft and Hard magnets.
- 2c S-2003 Explain the effects of Stress and Temperature on the steady state creep rate.
- 2d S-2003 How do you enhance creep resistance of steel ? Which temperature is important for a creep resistant alloy?
- 3a S-2003 What do you mean by dislocation density ? How does it influence various mechanical properties ?
- 3b S-2003 Explain the cause of brittle fracture of ductile material subjected to cyclic loading.
- 3c S-2003 On a Stress-Strain diagram illustrate the following (i) Elastic Limit (ii) Yield Stress (iii) Ultimate Tensile Strength
- 3d S-2003 How do you measure impact toughness ?
- 4a S-2003 In terms of electron energy band structure, discuss reasons for the difference in electrical conductivity between semiconductors and insulators.
- 4b S-2003 Briefly explain why the magnitude of the saturation magnetisation decreases with increasing temperature for ferromagnetic materials, and why ferromagnetic behaviour ceases above Curie temperature ?
- 5a S-2003 Explain the difference between Resolved Shear Stress and Critical Resolved Shear Stress.
- 5b S-2003 Do all metals have the same Slip system ? Why or why not ?
- 5c S-2003 Sketch Edge and Screw dislocations.
- 5d S-2003 Why are most metals and alloys used in engineering applications polycrystalline in nature ?
- 6a S-2003 Give compositions, properties and applications of (i) Gun metal (ii) Duralumin.
- 6b S-2003 Draw steel portion of iron-carbon phase diagram and give classification of steel based on their structure.
- 6c S-2003 Explain difference between (i) Hot working and Cold working (ii) Hot shortness and Cold shortness.
- 6d S-2003 Distinguish between martempering and austempering giving suitable examples for their applications.
- 7a S-2003 Explain TTT curves for a steel. How are they drawn ?

- 7b S-2003 How do the alloying elements affect these TTT curves? Explain with sketches.
- 7c S-2003 Briefly describe the phenomenon of superheating and supercooling. Why do they occur?
- 7d S-2003 Provide two reasons why martensite is so hard and brittle?
- 8a S-2003 Briefly describe the microstructural difference between spheroidite and tempered martensite.
- 8b S-2003 Explain the tempered martensite is much harder and stronger than spheroidite.
- 8c S-2003 Difference between the steel used for cutting tools and forming dies, with reference to the heat treatment of them.
- 8d S-2003 Explain in brief the Baushinger effect.
- 1a W-2003 Draw the following lattices BCC, FCC and HCP. Determine for each (i) Effective number of atoms (ii) Packing Co-ordination number
- 1b W-2003 Explain Rutherford's model of an atom and mention its disadvantages. How was Bohr's model better than Rutherford's model?
- 2a W-2003 Draw the stress strain curve for (i) Brittle material (ii) Ductile material. And give examples for each.
- 2b W-2003 The engineering stress and strain at fracture were found to be 450 Mpa and 0.63 respectively. Determine the true stress and true strain.
- 2c W-2003 Define Creep and Fatigue. How is creep and fatigue data presented? Give neat sketches.
- 2d W-2003 Mention the mechanisms responsible for thermal conductivity in materials. What is the dominant mechanism in each?
- 3a W-2003 With energy band gap diagrams differentiate between insulators, conductors and semiconductors.
- 3b W-2003 Define (i) Curie Temperature (ii) Anti Ferromagnetism (iii) Diamagnetism (iv) Permeability.
- 3c W-2003 Mention at least one application of the following (i) Hard magnets (ii) Soft magnets (iii) Dielectrics (iv) Semiconductors (v) Ferroelectrics (vi) Superconductors.
- 4a W-2003 Discuss the martensite transformation. What are  $M_s$  and  $M_f$  temperatures? What factors determine the transformation temperature?
- 4b W-2003 Define Hardness and Hardenability.
- 4c W-2003 Describe Jominy end quench test.
- 4d W-2003 Mention the factors that affect Hardenability.
- 5a W-2003 Define (i) Polymerisation (ii) degree of polymerisation (iii) Vulcanisation.

- 5b W-2003 Define corrosion. Mention various forms. Discuss the corrosion control measures.
- 6a W-2003 Differentiate between (i) Slip and twinning (ii) Hot and Cold working (iii) Elastic and Plastic deformation.
- 6b W-2003 Briefly explain (i) Bauschinger's effect (ii) Season Cracking (iii) Work hardening (iv) Polygonisation.
- 6c W-2003 Calculate the critical resolved shear stress in the following diagram
- 7a W-2003 Draw a T-T-T diagram of an eutectoid steel and label all areas and phases.
- 7b W-2003 What is Annealing ?
- 7c W-2003 Explain Recovery, Recrystallization and Grain Growth.
- 8a W-2003 Write a note the effect of alloying element additions to a plain carbon steel.
- 8b W-2003 Give some applications for following (i) Medium Carbon Steel (ii) High Carbon Steel (iii) Cast Iron
- 8c W-2003 Write notes on (i) Babbit materials (ii) Nuclear Metals (iii) Die Steels (iv) Magnetic Alloys.
- 1a S-2004 An element with an atomic number 50 has all it's iner energy levels filled up expect 4f level, which is empty. What is it's expected valence.
- 1b S-2004 State and briefly explain the Pauli's exclusion principle.
- 1c S-2004 Topaz, an orthorhombic semi-precious stone has a ratio of a:b:c of 0.529:1:0.477. Find the Miller indices of a plane whose intercept is as below : 0.264:1:0.238.
- 1d S-2004 A 3.5 mm titanium wire is drawn through a 3 mm diameter die, producing a wire having a yield strength of 550 MPa and a tensile strength of 550 MPa. Determine the final diameter of the wire. [Given the modulus of elasticity of titanium = 112 GPa].
- 2a S-2004 Draw a neat sketch of iron-carbon phase diagram and label the various phase fields. Write down the various reactions occurring in this system.
- 2b S-2004 Outline the differences between the following pairs: (i) Slip and Twinning (ii) Fatigue and Creep (iii) Extrinsic and Intrinsic semiconductor (iv) homogeneous and Heterogeneous nucleation (v) Hot and Cold working.
- 3a S-2004 With the help of suitable diagram, explain the grain growth pattern in a sand cast steel containing 0.35 % carbon. Describe the process to refine the grain structure in such a steel.
- 3b S-2004 Describe a practical method of assessing the depth of hardening of a steel.
- 3c S-2004 Compare the methods available for increasing the creep strength of a crystalline solid.
- 4a S-2004 What are the self-lubricating bearings? Give three suitable examples of the materials used and state their application also.

- 4b S-2004 Show how the True-Stress true-Strain diagram helps to explain the extent of plastic deformation and strain of materials.
- 4c S-2004 State the objectives of pre-sintering and sintering.
- 5a S-2004 Give a brief account of galvanic corrosion of metals.
- 5b S-2004 Outline the factors which control the increasing sensitivity of alloys to intragranular corrosion.
- 5c S-2004 The microstructure of an iron-carbon alloy at 800 degree centigrade contains 25 % Fe<sub>3</sub>C, and 75 %  $\gamma$  (have). Calculate the total carbon content of the alloy with the help of lever rule.
- 5d S-2004 With the help of four-parameter model explain the behaviour of polymer.
- 6a S-2004 What are High Speed Steels ? Give the composition, properties and applications of die steel.
- 6b S-2004 Mention the important requirements of electrical insulators.
- 6c S-2004 Explain the anisotropy and magnetostriction of magnetic materials. How do they affect the permeability of materials ?
- 7a S-2004 What are Cermets ? State their basic properties and uses.
- 7b S-2004 What is meant by Brittle Transition Temperature of the material ? How it can be estimated ? Name a polymer which retains its ductility even upto 100 degree centigrade and explain with suitable reasonings.
- 7c S-2004 Define Monomer and Polymer. Write the typical polymeric repeat structures for both addition and condensation polymerisation. Which of the method is expected to result in branched structure ? Explain.
- 8a S-2004 Explain what is meant by the terms piezoelectric and pyroelectric when applied to materials. How would you determine whether or not a material was (i) Piezoelectric (ii) Pyroelectric (iii) ferroelectric.
- 8b S-2004 Explain how Annealing, Normalising and Hardening of steel is carried out. Discuss the various objectives of these heat treatment processes.
- 1a W-2004 (i) Write down the electronic configurations of atoms having atomic numbers Z=10, Z=18 and Z=26. (ii) Explain the reason for poor conductivity of insulators (iii) Draw the nature of Bohr model of a hydrogen atom (iv) How many atoms are there in 1 gm of copper? Given atomic weight of copper is 63.5 gm/mol. And Avogadro's number = 6.023 x 10<sup>23</sup>.
- 1b W-2004 (i) Name the types of primary bonds in following solids Silica [SiO<sub>2</sub>], Aluminium [Al], Cesium Chloride [CsCl]. (ii) Draw conventional unit cells for the following solids Gamma iron, BCC-iron, Graphite (iii) On the basis of the crystal structure calculate the packing factor of FCC lattice. Also calculate the atomic radius of iron at 20 degree centigrade. Avogadro's constant is 0.287 nm.
- 2a W-2004 (i) Regroup the materials in order of conductors, semiconductors and insulators : Diamond, Silicon, Graphite, Polyethylene and Aluminium (ii) Why metals are good conductors ? (iii) On increasing the temperature, why does the electrical conductivity of metals in general decrease but those of insulators increases ? (iv) Describe briefly the mechanism of electrical conduction in metals.

of a n-type silicon semiconductor.

- 2b W-2004 (i) What is Ferromagnetism ? How does it differ from diamagnetism ? (ii) Draw the conventional B-H curves for a hard magnet and a soft magnet, indicating their significance.
- 3a W-2004 (i) Draw the nature of engineering Stress-Strain diagrams for gray cast iron and 70/30 brass [Cartridge brass]. Does the engineering Stress-Strain diagram differ from load-elongation diagram ? (iii) What are the units of Engineering Strain and True Strain in MKS system ?
- 3b W-2004 Derive the relationship between True Stress and Engineering Stress and True Strain with Engineering Strain.
- 3c W-2004 Draw the nature of S-N [Stress vs. Number of cycles of failure] curve of fatigue failure for medium carbon steel and aluminium, indicating their endurance limits. Why is fatigue strength lower than tensile strength ?
- 4a W-2004 (i) Why is corrosion called an electrochemical phenomenon ? (ii) Write down the Nernst Equation (iii) The standard EMF of a standard Mg-Cu galvanic cell is -2.70 V. If the standard half-cell EMF for the oxidation of Mg is -2.36 V, what is the standard half-cell EMF of copper ? (iv) Draw the electrode kinetic behaviour of a pure metal [say Zinc] in anodic polarization, schematically indicating  $E_{corr}$  and  $I_{corr}$ .
- 4b W-2004 (i) Give examples of galvanic corrosion and pitting corrosion (ii) Why are pure metals more corrosion resistant than impure metals ?
- 4c W-2004 (i) Explain Homopolymer and Copolymer, with their schematic molecular chain arrangements. (ii) If a particular polyethylene has a molecular mass of 420,000 gm/mol, what is the average degree of polymerisation ?
- 5a W-2004 (i) Define Slip, Twinning, Burger's Vector, Jog, Edge dislocation, with schematic diagrams [Burger's Vector is shown in a Burger's Circuit] (ii) What are the principal slip planes and slip directions for pure Zinc ? (Draw schematic diagrams) (iii) Why do single crystals of pure FCC metals like Silver have a low value of critical resolved shear stress compared to Ag-Cu alloy for the same orientation (iv) A brass sheet is 9.5 mm thick and is cold rolled with a 30% reduction in thickness. What will be the final thickness of the sheet ? Will there be any gain in mechanical properties in the cold rolled product? Explain (v) What is the ductile to brittle impact transition temperature ?
- 6a W-2004 (i) What do you mean by Recrystallisation Temperature ? (ii) If it takes  $5 \times 10^3$  min to recrystallize a piece of metal at 250 degree centigrade and 360 min at 300 degree centigrade completely, what is the activation energy for the recrystallization process, assuming the process obeys the Arrhenius type rate equation and the time to recrystallize =  $C \cdot e^{Q/RT}$ . Given  $R = 8.314 \text{ J/[Mol.K]}$ , T is in Kelvins, Q is the activation energy in J/Mol and C is a constant (iii) Distinguish between Hot working and Cold working (iv) Draw the nature of high temperature creep curves and indicate their differences.
- 6b W-2004 (i) Explain the stages of a cup and cone fracture (ii) Why are surface hardening treatments often used on the shafts of steel ? (iii) On the basis of the Hall-Petch equation, say how can the polycrystalline metal be strengthened ? (iv) List two ways of processing by which preferred orientation of grains can be obtained in a metal.
- 7a W-2004 (i) Draw the cooling curves for Martempering and Austempering operations for a eutectoid plain carbon steel superimposed on TTT diagrams [Use separate diagrams] (ii) How are the eutectoid temperature of steels affected by the additions of austenite or ferrite stabilizing alloying elements (iii) Differentiate between any two Annealing treatments.

Normalising or Hardness and Hardness and Hardenability or Brass and Bronze.

- 7b W-2004 Define any three Pearlite, Bainite, Martensite, Austenite, Critical cooling rate, Proeutectoid cementite.
- 8a W-2004 Justify (i) Multiple tempering is often used in heat treatment of alloy tool steels (ii) Die casting Silumin alloys contain 10-13 % silicon in aluminium (iii) Martensitic transformation is a diffusionless process (iv) Sea water corrosion of brass is an example of galvanic corrosion (v) The strength of the Maraging steels is not due to martensite.
- 8b W-2004 Write short note on Precipitation hardening or Define Vacancy, Polymorphism, Poisson's ratio, Insulator series.
- 1a S-2005 What is Burger's Vector ? Show it by drawing a Burger Circuit. What is Frank read source ? State its importance in plastic deformation.
- 1b S-2005 Distinguish between (i) Slip and Cross Slip (ii) Sessile dislocation and Glissile dislocation.
- 1c S-2005 What is critical resolved shear stress ? Derive its formulae.
- 1d S-2005 Calculate the degree of freedom of ice and water kept in a beaker at 1 atmosphere pressure.
- 2a S-2005 State Fick's law of diffusion. How can it help you in problems of Case Carburising ? Given an activation energy of 100 kJ/Mol, for the diffusion of carbon in FCC iron and an initial temperature of 1000 kelvin, find the temperature at which the diffusion coefficient will increase by a factor of 10 [ $R=8.314 \text{ J/Mol.K}$ ] Will you use a very high temperature ?
- 2b S-2005 What is a phase ? What is the difference between alpha iron and ferrite ? Define an invariant reaction with an example.
- 2c S-2005 Difference between (i) Phase Rule and Phase Diagram (ii) Solvus Line and Solidus Line.
- 3a S-2005 Explain Lever Rule with a Tie Line. Find the weight percentage of pro-eutectoid ferrite just above the eutectic temperature of a 0.3 % C-steel.
- 3b S-2005 Derive the relationship between True Strain and Engineering Strain. What is Resilience ? Why is it important for a material ?
- 3c S-2005 Describe the Yield Point Phenomenon. Draw the engineering Stress-Strain diagram of a ductile material. Why does necking occur during tension test of ductile material ?
- 3d S-2005 Justify (i) Zinc is not ductile as Copper (ii) Cold working increases hardness of materials (iii) Steel is a brittle material at sub-zero atmosphere.
- 4a S-2005 Suggest one suitable material for each of the following (i) file Cabinet (ii) Water Tap (iii) Manhole Cover (iv) Chair (v) Glass Cutter.
- 4b S-2005 Explain with reasons (i) Ceramics are very hard (ii) Solar cells are semiconductors with p-n junction (iii) high temperature creep is a diffusion controlled process (iv) Brittle fracture commonly occurs in Grey Cast Iron (v) Brass is stronger than Copper at room temperature.

- 5a S-2005 (i) Why has ferrite very low solubility of carbon, while austenite has high solubility of carbon (ii) What is hcp? Why it is not so high in plain carbon steels? (iii) Draw the Peritectic reaction of Fe-C system.
- 5b S-2005 (i) State the advantages of Normalising over Annealing (ii) What is critical cooling rate? Why is the shape of TTT diagram in form of english letter C? (iii) What is Tempering? Is it essential for high carbon steel after quenching? Write the scientific names of following polymers with one of their typical use: Teflon, ABS.
- 6a S-2005 Explain a chain polymerisation reaction. What is the degree of polymerisation? If a particular type of polymer has a molecular mass of 140,000 g/mol, what is its degree of polymerisation?
- 6b S-2005 Distinguish between Homopolymer and Copolymer. State the basic structural units of PMMA and nylon 6,6 and their properties.
- 6c S-2005 Define a semiconductor and a transistor.
- 7a S-2005 Differentiate between Ceramics and Glass, with examples. What is the Glass Transition Temperature? What type of glass is used in spectacle lenses?
- 7b S-2005 Explain the reason for the rising popularity of Pure Oxide Ceramics over traditional refractories. What is mullite? Where is it commonly being used?
- 7c S-2005 Draw the crystallographic unit of  $\text{SiO}_4^{4-}$  iron. What is Mullite? Explain Slip casting.
- 7d S-2005 What is Alnico? Explain Patenting.
- 8a S-2005 (i) Why are monovalent metals like Silver or Copper so conductive? (ii) Discuss dielectric constant and dielectric strength for ceramics (iii) Name two important ceramic insulators with their properties.
- 8b S-2005 (i) What is Hysteresis Loop? Explain its importance (ii) Distinguish between Diamagnetism and Paramagnetism.
- 8c S-2005 What is E-glass? Where it is commonly used?
- 8d S-2005 By energy Band Model explain the electrical conduction of an intrinsic semiconductor.
- 1a W-2005 Calculate the volume of FCC unit cell in terms of the atomic radius R. Show that the atomic packing factor of FCC cell is more than that of BCC.
- 1b W-2005 Difference between Frenkel pairs and Shottkey defects.
- 1c W-2005 Explain why interstitial atoms such as C in Fe, can diffuse more rapidly, compared to vacancies.
- 2a W-2005 A tensile sample of polycrystalline copper has been loaded in tension to an arbitrary stress,  $\sigma_0$  exceeding the yield stress  $\sigma_y$  and then unloaded. (i) With a schematic true stress-true strain curve representing the loading and unloading behaviour, show how elastic and plastic strains can be determined. (ii) If the sample was a single crystal of copper subjected to compression right after unloading in tension, will the yield stress be equal to, more or less than  $\sigma_0$ ? Explain.

- 2b W-2005 Assuming that the true stress-true strain curve follows the relation :  $\sigma = \sigma_0 + K \epsilon^n$ , where  $\sigma$  is the true stress and  $\epsilon$  is the true strain. Explain how is the behavior of viscoelastic solid differ from those of from other two.
- 2c W-2005 Draw schematic stress strain curves for ideally elastic, ideally plastic and viscoelastic solid. Explain how is the behavior of viscoelastic solid differ from those of from other two.
- 3a W-2005 Explain why is twinning associated with homogeneous shear, though atoms are displaced by equal distance.
- 3b W-2005 What are the three regimes of a typical creep curve, showing creep strain against time ? Distinguish between the deformation mechanisms involved in the three stages of creep.
- 3c W-2005 What is the fundamental difference between stress relaxation test and a creep test ?
- 4a W-2005 Explain on the basis of dislocation theory, why ceramics and intermetallic compounds are brittle, while metals are ductile ?
- 4b W-2005
- 4c W-2005 Mild steel samples A, B and C have been fractured by impact at liquid nitrogen temperature and in tension at a strain rate of  $10^{-5} \text{ s}^{-1}$  at 700 degree Centigrade in air. Explain with reasons the differences in fracture surface morphology.
- 4d W-2005 What are the differences in grain structure and dislocation substructure do you expect after working different samples of same strip of copper through similar reduction at room temperature and 0.6 of its absolute melting point ?
- 5a W-2005 What are the eutectoid and eutectoid reactions in the Fe-C binary phase diagram ?
- 5b W-2005 If you carry out impact test on 0.4% C steel, subjected to heat treatments : (i) quenching in brine after solution treating at the A3, and (ii) tempering at 50 degree centigrade for 1 hour. Will the results vary ? Explain.
- 5c W-2005
- 5d W-2005 Differentiate between age hardening and dispersion hardening, emphasizing on how dislocations interact with second phase and suitability for application of materials strengthened by those methods at high temperature.
- 6a W-2005 What are the two mechanisms responsible for thermal conductivity in materials ? Why are amorphous ceramics and polymers less thermally conductive, compared to those, which are crystalline ?
- 6b W-2005 Explain two different sources of thermal stresses in materials, which could be of any dimensions and used as structural components. How is the thermal shock resistance dependent on thermal conductivity, coefficient of thermal expansion, elastic modulus, and anisotropy along crystallographic directions ?
- 6c W-2005 How will you select and design materials to be used in (i) turbine blades of jet engines, operating at 1300 degree centigrade, (ii) propeller of a ship travelling in the Arctic ocean. Emphasise on requirements of microstructure and mechanical properties.
- 7a W-2005 What do you mean by glass transition temperature ? How do the plots showing variation of specific volume with temperature for amorphous glass ceramic and a crystalline solid differ ?

- 7b W-2005 Why are ionic ceramics used as dielectric in capacitors, what does dielectric constant depend on ? What is ferro-electric ceramics, is it necessary for iron to be present ?
- 7c W-2005 Distinguish between structure and properties of thermosetting and thermoplastic resins.
- 7d W-2005 Is substitutional solid solution of ceramics possible ? What is the additional condition, which is not a requirement for metals ?
- 8a W-2005 Distinguish between paramagnetism and ferromagnetism, explaining the mechanism involving electron spin.
- 8b W-2005 Draw the hysteresis loop for hard and soft magnets, and explain the differences in behaviour in response to magnetic field with emphasis on the magnetization parameters.
- 8c W-2005 Distinguish between addition and condensation polymerization, and state which of those are applied for polyethylene and poly carbonates.
- 8d W-2005 Using the character of electron distribution in different energy bands, explain the cause behind a material acting as conductor, and other acting as insulator.
- 1a S-2006 Explain semiconductors, intrinsic and extrinsic semiconductors.
- 1b S-2006 mention four strengthening mechanisms of metals and alloys. Explain any one of them.
- 1c S-2006 Why are metals mostly ductile and ceramics mostly brittle at room temperature ?
- 2a S-2006 What are the invariant points [degrees of freedom=0] in a binary phase diagram with eutectic ?
- 2b S-2006 Explain the terms isomorphous, eutectic, peritectic and eutectoid systems.
- 2c S-2006 Explain how will you determine the elastic and plastic components of strain from a schematic stress-strain diagram showing loading and unloading in plastic strain range.
- 2d S-2006 Define the following terms (i) Yield Strength (ii) Tensile Strength (iii) Poisson's Ratio
- 3a S-2006 Explain the mechanism of creep.
- 3b S-2006 Distinguish between ductile and brittle fracture.
- 3c S-2006 What do you mean by Normalising and Tempering and indicate how those heat treatments affect the properties of steel ?
- 3d S-2006 A sodium silicate glass has no surface defects as etching has removed them, but has a crack inside of length 2 cm. Calculate the surface energy of glass if fracture strength = 100 MNm<sup>-2</sup> and Young's modulus = 70 GNm<sup>-2</sup>.
- 4a S-2006 Write a note on viscoelastic properties of materials, showing schematic plots of variation of stress with strain and with time.
- 4b S-2006 Differentiate between Edge and Screw dislocation.

- 4c S-2006 Explain cold working, warm working and hot working.
- 4d S-2006 What is Buschinger's Effect ?
- 5a S-2006 Discuss the mechanism of age hardening of Al alloys.
- 5b S-2006 How is hardenability is carried out ?
- 5c S-2006 Discuss the heat transfer characteristics during quenching and it's effects on mechanical properties.
- 5d S-2006 Disciss the nitriding process.
- 6a S-2006 What are hthe effects of high temperature on mechanical properties of metals ?
- 6b S-2006 What will be your considerations for choice of an alloy for high temperature applications ?
- 6c S-2006 A continuous and aligned glass fibre reinforced composite consists of 40 vol % of glass fibre having a modulus of 69 Gpa and 60 vol % of a polyester resin that, when hardened, displays a modulus of 3.4 Gpa. Calculate the longitudinal elasticity of this composite in the longitudinal directions.
- 6d S-2006 Discuss Zone Theory of solids and explain Zones in conductors and insulators.
- 7a S-2006 A transformer core is wound with a coil carrying an alternating current at a frequency of 50 Hz. Assuming the magnetism to be uniform throughout the core volume of  $0.02 \text{ m}^3$ . calculate the hysteresis loss. The hysteresis loop has an area of 80,000 units, when teh axes are drawn in units of  $10^{-4} \text{ Wbm}^{-2}$  and  $10^{-2} \text{ Am}^{-1}$ .
- 7b S-2006 Distinguish between soft and hard magnets.
- 7c S-2006 Write the peritectic, eutectic and eutectrial reaction of Fe-Fe<sub>3</sub>C phase diagram.
- 7d S-2006 Discuss the cooling process of 0.6 % C steel from 1500 degree centigrade to room temperature.
- 8a S-2006 Give some applications of Polyethylene, Nylon and Polyester.
- 8b S-2006 What is Polymerization ? With the help of suitable examples, compare and contrast the process of addition polymerization and condensation polymerization.
- 8c S-2006 Name two commonly used thermosetting polymers and their applications.
- 8d S-2006 Why are fibre glass reinforced composites used extensively ?